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2A, 200V - 600V Glass Passivated Super Fast Rectifiers

FEATURES

- Glass passivated chip junction
- High efficiency, Low VF
- Negligible leakage current
- High current capability
- High surge current capability
- Low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



Case: DO-204AC (DO-15)

Molding compound, UL flammability classification rating 94V-0

Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free)

 $\textbf{Terminal:} \ \mathsf{Pure} \ \mathsf{tin} \ \mathsf{plated} \ \mathsf{leads}, \ \mathsf{solderable} \ \mathsf{per} \ \mathsf{JESD22}\text{-}\mathsf{B102}$

Meet JESD 201 class 2 whisker test **Weight:** 0.4g (approximately)







| DO-204AC | (DO | -15) |
|----------|-----|------|
|----------|-----|------|

| MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted) | | | | | | |
|--|--------------------|--------------|--------|--------|------|--|
| PARAMETER | SYMBOL | SF2L4G | SF2L6G | SF2L8G | UNIT | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | 400 | 600 | V | |
| Maximum RMS voltage | V_{RMS} | 140 | 280 | 420 | V | |
| Maximum DC blocking voltage | V _{DC} | 200 | 400 | 600 | V | |
| Maximum average forward rectified current | I _{F(AV)} | 2 | | | Α | |
| Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 50 40 | | 40 | А | |
| Maximum instantaneous forward voltage (Note 1) @ 2 A | V _F | 0.95 | 1.3 | 1.7 | V | |
| Maximum reverse current @ rated V_R $T_J=25^{\circ}C$ $T_J=125^{\circ}C$ | I _R | 1 100 | | μΑ | | |
| Maximum reverse recovery time (Note 2) | t _{rr} | 35 | | ns | | |
| Typical junction capacitance (Note 3) | CJ | 40 | 40 20 | | pF | |
| Typical thermal registeres | $R_{	heta JL}$ | 17 | | | °C/W | |
| Typical thermal resistance | $R_{\theta JA}$ | 65 | | | | |
| Operating junction temperature range | TJ | - 55 to +150 | | °C | | |
| Storage temperature range | T _{STG} | - 55 to +150 | | | °C | |

Note 1: Pulse test with PW=300 μ s, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.



| ORDERING INFORMATION | | | | | |
|----------------------|----------|--------------|--------------|---------|------------------------|
| PART NO. | PART NO. | PACKING CODE | PACKING CODE | PACKAGE | PACKING |
| | SUFFIX | | SUFFIX (*) | | |
| 05010 | | A0 | | DO-15 | 1,500 / Ammo box |
| SF2LxG (Note 1) | Н | R0 | G | DO-15 | 3,500 / 13" Paper reel |
| (14010-1) | | B0 | | DO-15 | 1,000 / Bulk packing |

Note 1: "x" defines voltage from 200V (SF2L4G) to 600V (SF2L8G)

^{*:} Optional available

| EXAMPLE | | | | | |
|---------------|----------|--------------------|--------------|------------------------|--------------------------------------|
| PREFERRED P/N | PART NO. | PART NO. SUFFIX | PACKING CODE | PACKING CODE SUFFIX | DESCRIPTION |
| SF2L4GHA0G | SF2L4G | Н | A0 | G | AEC-Q101 qualified Green compound |

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

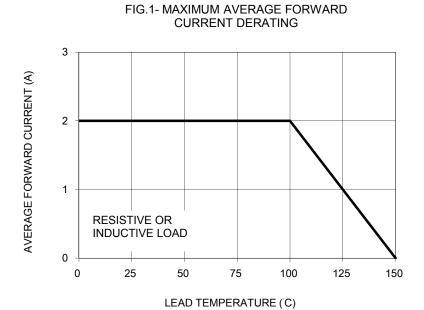
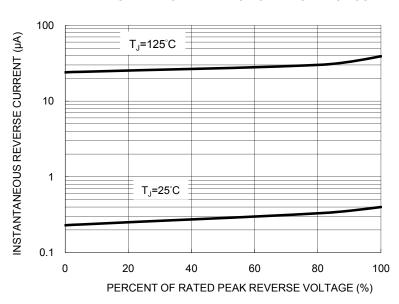
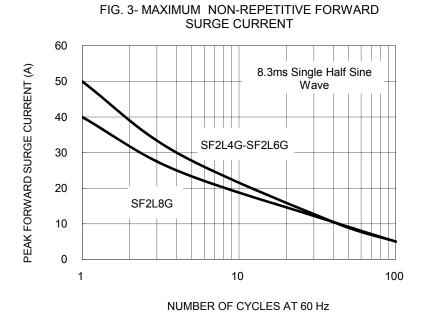


FIG.2- TYPICAL REVERSE CHARACTERISTICS





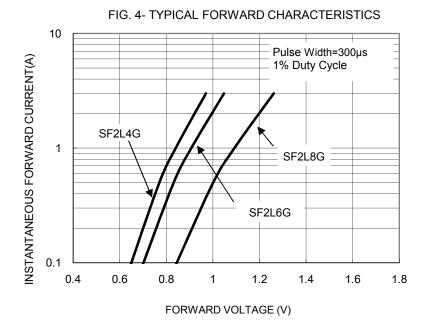
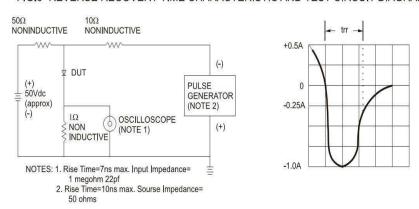


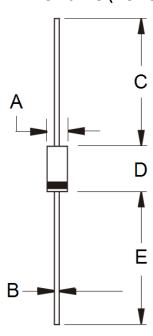


FIG. 5- TYPICAL JUNCTION CAPACITANCE 150 JUNCTION CAPACITANCE (pF) f=1.0MHz Vsig=50mVp-p 125 100 75 SF2L4G 50 25 SF2L6G-SF2L8G 0 100 1000 0.1 10 REVERSE VOLTAGE (V)

FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



PACKAGE OUTLINE DIMENSIONS DO-204AC (DO-15)



| DIM. | Unit | (mm) | Unit (inch) | | |
|------|-------|------|-------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 2.60 | 3.60 | 0.102 | 0.142 | |
| В | 0.70 | 0.90 | 0.028 | 0.035 | |
| С | 25.40 | - | 1.000 | - | |
| D | 5.80 | 7.60 | 0.228 | 0.299 | |
| E | 25.40 | - | 1.000 | - | |

MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound YWW = Date Code

F = Factory Code



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